



#### LOW POWER QUAD OPERATIONAL AMPLIFIERS

### **Description**

The AS324/324A consist of four independent, high gain and internally frequency compensated operational amplifiers. They are specifically designed to operate from a single power supply. Operation from split power supplies is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage. Typical applications include transducer amplifiers, DC gain blocks and most conventional operational amplifier circuits.

The AS324/324A series are compatible with industry standard 324. The AS324A has more stringent input offset voltage than AS324.

The AS324 is available in SOIC-14, DIP-14 and TSSOP-14 packages, and the AS324A is available in SOIC-14 package.

#### **Features**

- Internally Frequency Compensated for Unity Gain
- Large Voltage Gain: 100dB (Typical)
- Low Input Bias Current: 20nA (Typical)
- Low Input Offset Voltage: 2mV (Typical)
- Low Supply Current: 0.5mA (Typical)
- Wide Power Supply Voltage Range:
  - Single Supply: 3V to 36V
  - Dual Supplies: ±1.5V to ±18V
- Input Common Mode Voltage Range Includes Ground
- Large Output Voltage Swing: 0V to V<sub>CC</sub> -1.5V
- Power Drain Suitable for Battery Operation

# **Applications**

- Battery Charger
- Cordless Telephone
- Switching Power Supply

# **Pin Assignments**

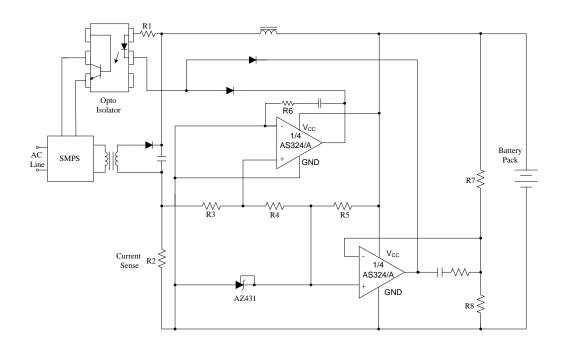
#### (Top View) (Top View) **OUTPUT 1** 14 **OUTPUT 4 OUTPUT 1 OUTPUT 4** 14 INPUT 1-13 INPUT 4-INPUT 1-13 INPUT 4-INPUT 1+ 12 INPUT 4+ INPUT 1+ INPUT 4+ 12 4 $V_{CC}$ 11 **GND** 11 GND $V_{\text{CC}}$ INPUT 2+ 10 INPUT 3+ INPUT 3+ INPUT 2+ 10 INPUT 2-6 9 INPUT 3-INPUT 2-9 INPUT 3-OUTPUT 2 8 **OUTPUT 3** 8 **OUTPUT 3** OUTPUT 2

(SOIC-14/TSSOP-14 / M/G Package)

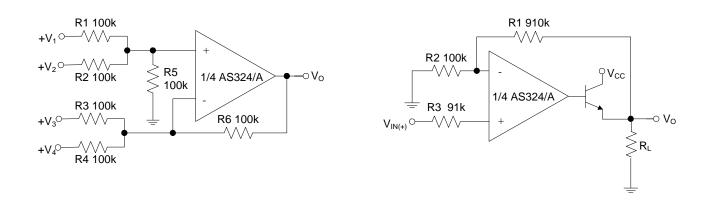
(DIP-14/ P Package)



# **Typical Applications Circuit**



**Battery Charger** 

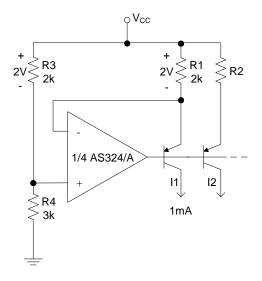


DC Summing Amplifier

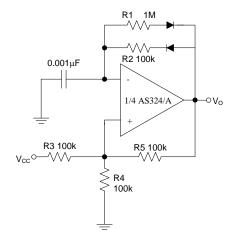
Power Amplifier



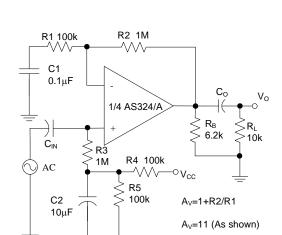
# **Typical Applications Circuit (Cont.)**



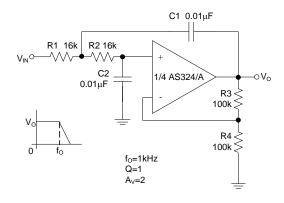
**Fixed Current Sources** 



**Pulse Generator** 



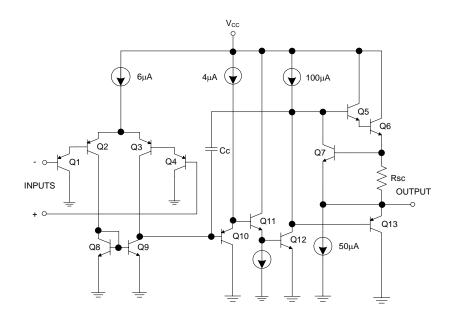
AC Coupled Non-Inverting Amplifier



DC Coupled Low-Pass RC Active Filter



# **Functional Block Diagram**



# **Absolute Maximum Ratings** (Note 1)

Symbol	Parameter	Rati	Unit		
Vcc	Supply Voltage	40		V	
V <sub>ID</sub>	Differential Input Voltage	40		V	
V <sub>IN</sub>	Input Voltage	-0.3 to 40		V	
P <sub>D</sub>		DIP-14	1130		
	Total Power Dissipation (T <sub>A</sub> = +25°C)	SOIC-14	800	mW	
		TSSOP-14	710		
TJ	Operating Junction Temperature	+150		°C	
T <sub>STG</sub>	Storage Temperature Range	-65 to +150		°C	
T <sub>LEAD</sub>	Lead Temperature (Soldering, 10 Seconds)	+260		°C	

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

# **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
Vcc	Supply Voltage	3	36	V
T <sub>A</sub>	Ambient Operating Temperature Range	-40	+85	°C





AS324/324A

**Electrical Characteristics** (Limits in standard typeface are for  $T_A = +25^{\circ}\text{C}$ , **bold** typeface applies over  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  (Note 2),  $V_{CC} = 5V$ , GND = 0V, unless otherwise specified.)

Symbol	Para	ameter	Conditi	Min	Тур	Max	Unit	
V <sub>IO</sub> Input Offset Voltage			A C 2 2 4	_	2	5	mV	
	land of Office ( ) / ellipses			AS324	-	-		7
	input Offset Voltage		$V_O = 1.4V$ , $R_S = 0\Omega$ , $V_{CC} = 5V$ to $30V$	A C 2 2 4 A	-	2	3	mV
				AS324 A	-	-	5	
ΔV <sub>IO</sub> /ΔΤ	Average Temperature Offset Voltage	Coefficient of Input	$T_A = -40 \text{ to } +85^{\circ}\text{C}$		-	7	-	μV/°C
l	Input Offset Current		L. L. V. OV		-	5	30	^
I <sub>IO</sub>	Input Offset Current		I <sub>IN</sub> + - I <sub>IN</sub> -, V <sub>CM</sub> = 0V		-	-	100	nA
	Innut Ding Current				-	20	100	<b>π</b> Λ
I <sub>BIAS</sub>	Input Bias Current		$I_{IN}$ + or $I_{IN}$ -, $V_{CM}$ = 0V		-	-	200	nA
$V_{IR}$	Input Common Mode	Voltage Range (Note 3)	V <sub>CC</sub> = 30V		0	_	V <sub>CC</sub> - 1.5	V
	0	oly Current	$T_A = -40 \text{ to } +85^{\circ}\text{C},$	V <sub>CC</sub> = 30V	-	1.0	3	mA
Icc	Supply Current		R <sub>L</sub> = ∞	V <sub>CC</sub> = 5V	-	0.7	1.2	
0	Large Circal Valtage	e Gain	$V_{CC} = 15V$ , $R_L \ge 2k\Omega$ , $V_O = 1V$ to 11V		85	100	-	- dB
G∨	Large Signal Voltage (				80	-	_	
OMPR	Occasion Maria Delega	Police Police	4.5))/	60	70	-	dB	
CMRR Common Mode Reject	in Ratio $DC$ , $V_{CM} = 0$ to	DC, $V_{CM} = 0$ to $(V_{CC})$	1.5)V	60	-	_		
DODD	PSRR Power Supply Rejection Ratio		V <sub>CC</sub> = 5 to 30V		70	100	-	
PSKK					60	-	_	dB
CS	Channel Separation		f = 1kHz to 20kHz		-	-120	-	dB
		Source	V <sub>IN</sub> + = 1V, V <sub>IN</sub> - = 0V, V <sub>CC</sub> = 15V, V <sub>O</sub> = 2V		20	40		mA
I <sub>SOURCE</sub>					20	_	-	
	Output Current	st Sink	V <sub>IN</sub> += 0V, V <sub>IN</sub> -= 1V, V <sub>CC</sub> = 15V, V <sub>O</sub> = 2V V <sub>IN</sub> += 0V, V <sub>IN</sub> -= 1V, V <sub>CC</sub> = 15V, V <sub>O</sub> = 0.2V		10	15	-	mA
I <sub>SINK</sub>					5	_	_	
					12	50	_	μΑ
Isc	Output Short Circuit Current to Ground		V <sub>CC</sub> = 15V		_	40	60	mA
Vон			V 00V D 015		26	_	_	
				$V_{CC} = 30V, R_L = 2k\Omega$		-	-	V
		$V_{CC} = 30V$ , $R_L = 10k\Omega$		27	28	_		
	Output Voltage Swing			27	_	_		
			V 5V D 40L2		-	5	20	//
$V_{OL}$			$V_{CC} = 5V$ , $R_L = 10k\Omega$		-	-	30	mV
0	The man all Desires of	DIP-1			-	24.78	_	0000
⊎JC	θ <sub>JC</sub> Thermal Resistance (Junction to Case)		SOIC-14	-	36.78	-	°C/W	

Notes:

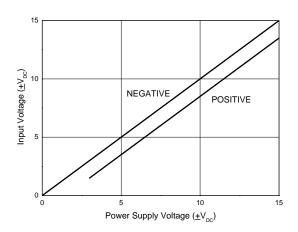
<sup>2.</sup> Limits over the full temperature are guaranteed by design, but not tested in production.

<sup>3.</sup> The input common-mode voltage of either input signal voltage should not be allowed to go negatively by more than 0.3V (at  $+25^{\circ}$ C). The upper end of the common-mode voltage range is  $V_{CC}$  -1.5V (at  $+25^{\circ}$ C), but either or both inputs can go to +36V without damages, independent of the magnitude of the  $V_{CC}$ .

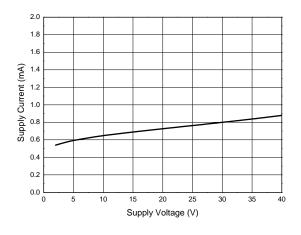


# **Performance Characteristics**

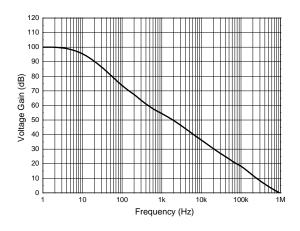
### **Input Voltage Range**



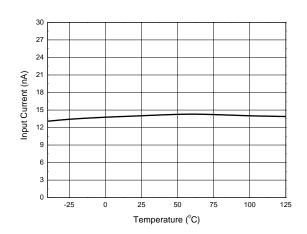
# **Supply Current**



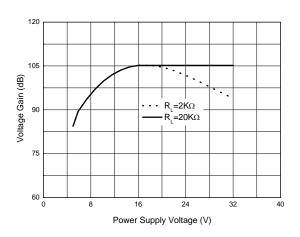
### **Open Loop Frequency Response**



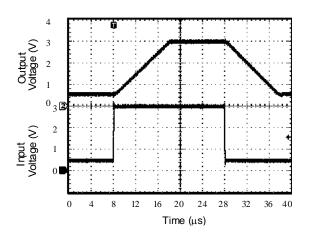
#### **Input Current**



### **Voltage Gain**



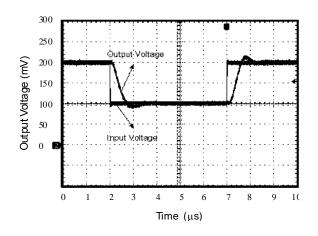
### **Voltage Follower Pulse Response**



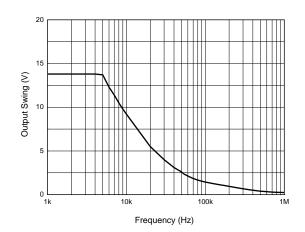


# **Performance Characteristics (Cont.)**

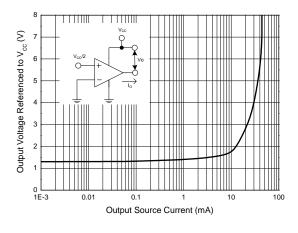
#### Voltage Follower Pulse Response (Small Signal)



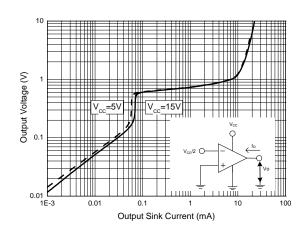
#### **Large Signal Frequency Response**



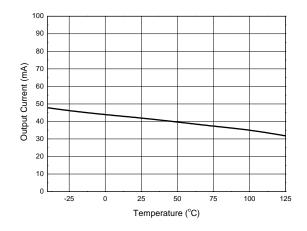
### **Output Characteristics: Current Sourcing**



### **Output Characteristics: Current Sinking**



### **Current Limiting**

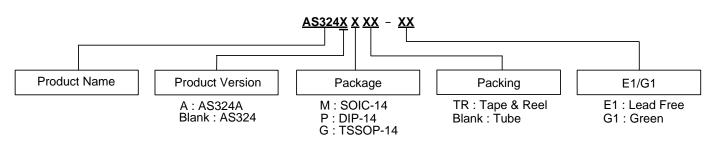






AS324/324A

# **Ordering Information**



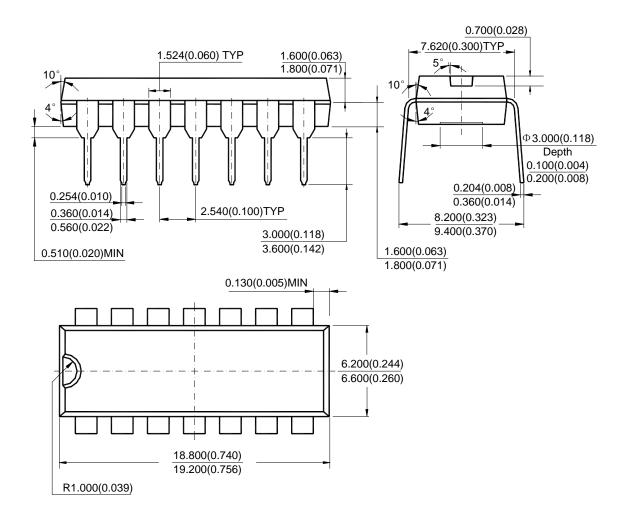
Diodes IC's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant. Products with "G1" suffix are available in green packages.

Package	Temperature Range	Part Number		Marking ID		
		Lead Free	Green	Lead Free	Green	Packing Type
		AS324M-E1	AS324M-G1	AS324M-E1	AS324M-G1	Tube
SOIC-14	-40 to +85°C	AS324MTR-E1	AS324MTR-G1	AS324M-E1	AS324M-G1	Tape & Reel
		AS324AM-E1	AS324AM-G1	AS324AM-E1	AS324AM-G1	Tube
		AS324AMTR-E1	AS324AMTR-G1	AS324AM-E1	AS324AM-G1	Tape & Reel
DIP-14		AS324P-E1	AS324P-G1	AS324P-E1	AS324P-G1	Tube
TSSOP-14		AS324GTR-E1	AS324GTR-G1	EGS324	GGS324	Tape & Reel



# Package Outline Dimensions (All dimensions in mm(inch).)

### (1) Package Type: DIP-14

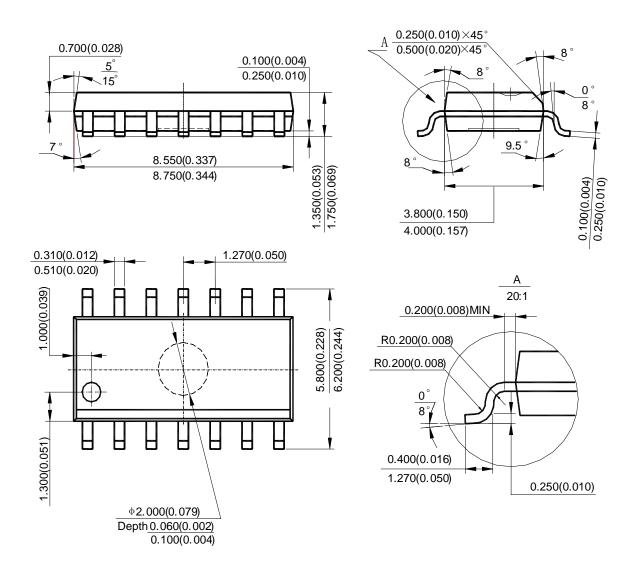


Note: Eject hole, oriented hole and mold mark is optional.



# Package Outline Dimensions (Cont. All dimensions in mm(inch).)

### (2) Package Type: SOIC-14

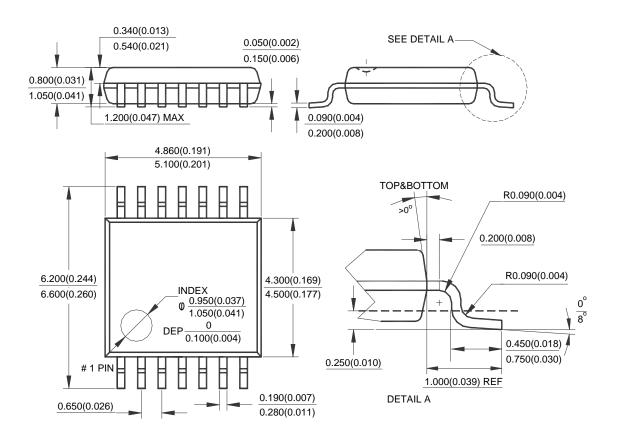


Note: Eject hole, oriented hole and mold mark is optional.



# Package Outline Dimensions (Cont. All dimensions in mm(inch).)

### (3) Package Type: TSSOP-14

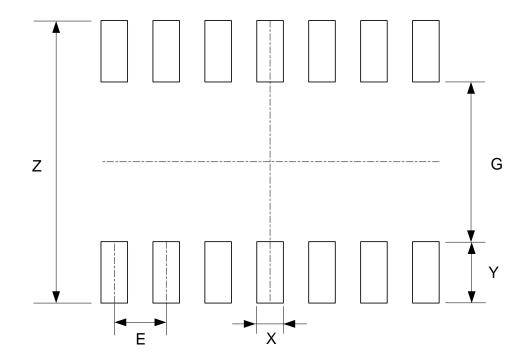


Note: Eject hole, oriented hole and mold mark is optional.



# **Suggested Pad Layout**

# (1) Package Type: SOIC-14

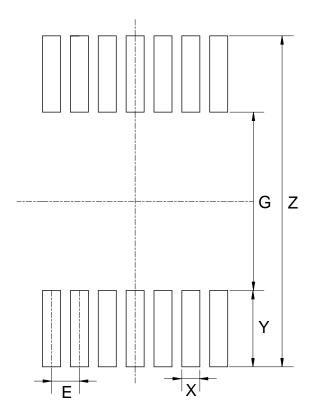


Dimensions	Z	G	X	Υ	E
Dimensions	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050



# Suggested Pad Layout (Cont.)

# (2) Package Type: TSSOP-14



Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	7.720/0.304	4.160/0.164	0.420/0.017	1.780/0.070	0.650/0.026



AS324/324A

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